

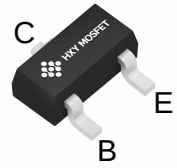


Features

- High current surface mount P P silicon switching transistor for Load management in portable applications

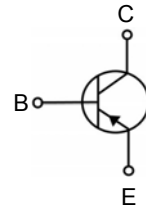
Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
PBSS5120T,215	SOT-23	589	3000



1. BASE
2. EMITTER
3. COLLECTOR

SOT-23



Maximum Ratings (Ta=25 unless otherwise noted)

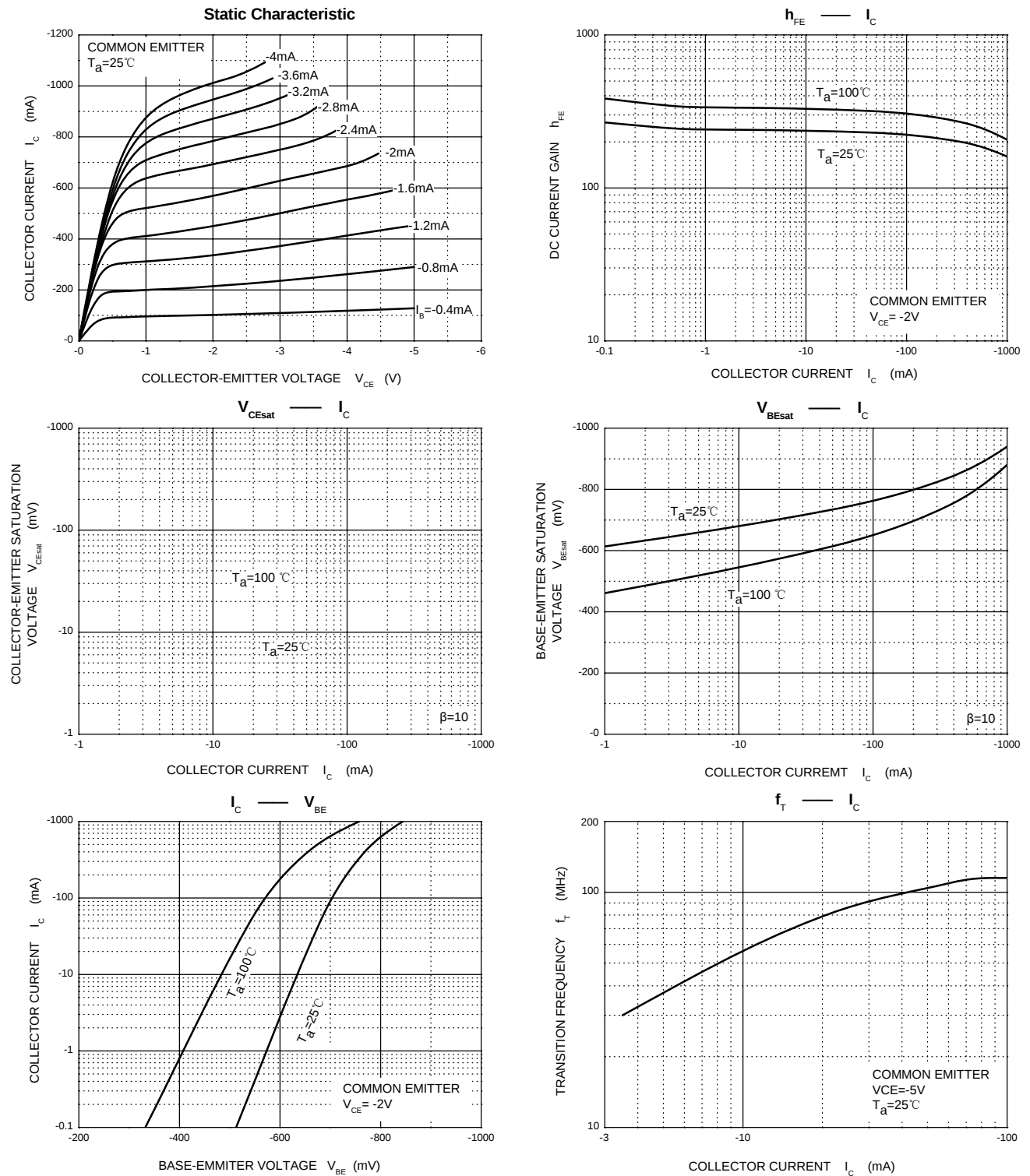
Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	-50	V
V_{CEO}	Collector-Emitter Voltage	-30	V
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current	-1	A
P_C	Collector Power Dissipation	310	mW
$R_{\theta JA}$	Thermal Resistance From Junction To Ambient	403	°C/W
T_J, T_{stg}	Operation Junction and Storage Temperature Range	-55~+150	°C

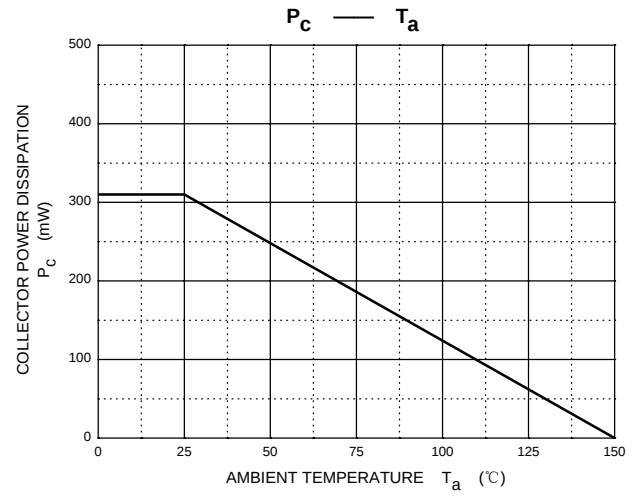
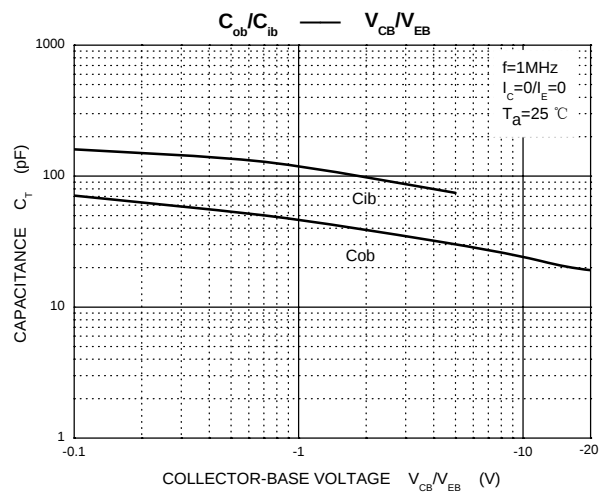
Electrical Characteristics (Ta=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C = -100\mu A, I_E = 0$	-50		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C = -10mA, I_B = 0$	-30		V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E = -100\mu A, I_C = 0$	-5		V
Collector cut-off current	I_{CBO}	$V_{CB} = -30V, I_E = 0$		-0.1	μA
Collector-emitter cut-off current	I_{CES}	$V_{CES} = -30V$		-0.1	μA
Emitter cut-off current	I_{EBO}	$V_{EB} = -4V, I_C = 0$		-0.1	μA
DC current gain	h_{FE1}	$V_{CE} = -2V, I_C = -1mA$	100		
	h_{FE2}	$V_{CE} = -2V, I_C = -500mA$	100	300	
	h_{FE3}	$V_{CE} = -2V, I_C = -1A$	80		
	h_{FE4}	$V_{CE} = -2V, I_C = -2A$	40		
Collector-emitter saturation voltage	$V_{CE(sat)1}$	$I_C = -500mA, I_B = -50mA$		-0.25	V
	$V_{CE(sat)2}$	$I_C = -1A, I_B = -100mA$		-0.3	V
	$V_{CE(sat)3}$	$I_C = -2A, I_B = -200mA$		-0.65	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = -1A, I_B = -100mA$		-1.2	V
Base-emitter Turn-on voltage	$V_{BE(on)}$	$V_{CE} = -2V, I_C = -1A$		-1.1	V
Transition frequency	f_T	$V_{CE} = -5V, I_C = -100mA, f = 100MHz$	100		MHz
Collector Output Capacitance	C_{ob}	$f = 1MHz$		15	pF

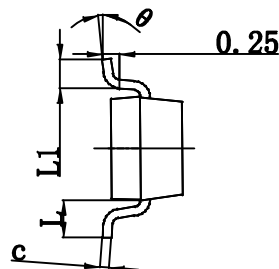
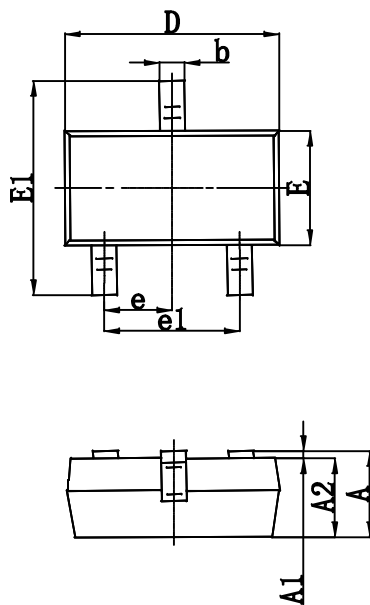


Typical Characteristics





SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°



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